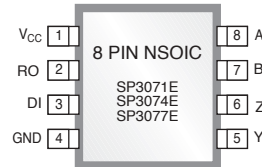# Sipex

PRELIMINARY

SP307XE

3.3V±15kV ESD-Protected RS-485/RS422 Transceivers

FEATURES

- 3.3V Operation
- Electrostatic Discharge (ESD) Protection for RS-485 I/O Pins
  ±15kV Human Body Model (Airgap & Contact)
- True Failsafe Receiver while maintaining EIA/TIA-485 Compatibility
- Hot Swap Input Structure on DE and $\overline{RE}$
- Enhanced Slew-rate Limiting Facilitates Error-Free Data Transmission on long transmission lines (SP3070E-SP3075E)
- Low-Current Shutdown Mode (Except SP3071E/SP3074E/SP3077E)
- Allow up to 256 Transceivers on the Bus
- Available in Industry-Standard 8-Pin SO Package

```
         ┌─────────────┐
V_CC  1 ─┤             ├─ 8  A
        │  8 PIN NSOIC │
RO    2 ─┤             ├─ 7  B
        │   SP3071E    │
DI    3 ─┤   SP3074E    ├─ 6  Z
        │   SP3077E    │
GND   4 ─┤             ├─ 5  Y
         └─────────────┘
```

Now Available in Lead Free Packaging

APPLICATIONS

- Lighting Systems
- Industrial Control
- Electric Meters
- Security Systems
- Instrumentation

DESCRIPTION

The SP307XE family contains differential line transceivers suitable for high speed bidirectional communication on multipoint bus transmission lines. They are designed for balanced data transmission and comply with both RS485 and RS422 EIA Standards. Each part contains one differential driver and one differential receiver. SP3071E, SP3073E, SP3074E, SP3076E, and SP3077E are full-duplex devices. SP3072E, SP3075E, and SP3078E are half-duplex devices.

SP3070E, SP3073E, SP3076E, and all half-duplex devices allow enable and disable both driver and receiver independently. The high impedance driver output is maintained over the entire common-mode voltage range from -7 to +12V.

The SP307XE family operates from a single 3.3V power supply. Excessive power dissipation caused by bus contention or by output shorting is prevented by short-circuit protection and thermal shutdown. This feature forces the driver output into high-impedance state if, during fault conditions, the absolute value of the output current exceeds 250mA or the junction temperature exceeds 165ºC.

Up to 256 transceivers may be connected simultaneously on a bus, but only one driver should be enabled at a time.

The receiver contains a fail-safe feature that results in a logic high state if the inputs are unconnected (floating), shorted or terminated.

The SP30XXE family is fabricated on BICMOS technology. All inputs and outputs have ESD protection. Bus pins are ESD protected up to ± 15kV from Air-Gap and Human Body Model Discharge and up to ±8kV Contact discharge (IEC 1000-4-2).

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{CC}...+6.0V
Input Voltage at control input pins ($\overline{RE}$, DE).........................-0.3V to 6V
Driver Input Voltage ($\overline{RE}$, DE)..-0.3V to 6V
Driver Output Voltage (A, B, Y, & Z)...................................-8V to +13V
Receiver Input Voltage (A, B)..-8V to +13V

Continuous Power Dissipation at Ta = 70°C
  8-pin SO (derate 5.88mW/°C above +70°C)..............................471mW
  8-pin PDIP (derate 9.29mW/°C above +70°C)...........................727mW
  14-pin SO (derate 8.33mW/°C above +70°C)............. ....667mW
  14-pin PDIP (derate 10mW/°C above +70°C).................. ....800mW
Operating Temperature Ranges
  SP307_EC__...0°C to +70°C
  SP307_EE__..-40°C to +85°C
Junction Temperature... ..+150°C
Storage Temperature Range..-65°C to +150° C
Lead Temperature (soldering, 10s)... +300° C

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature $T_{MIN} < T_A < T_{MAX}$. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25ºC.

PARAMETER	SYM.	MIN.	TYP.	MAX.	UNITS	CONDITIONS	
Differential Driver Output	V_{OD}	2		V_{CC}	V	RL=100Ω (RS-422), Figure 1	
		1.5		V_{CC}		RL=54Ω (RS-485), Figure 1	
				V_{CC}		No Load	
Change in Magnitude of Differential Output Voltage(1)	ΔV_{OD}			0.2	V	RL=54 or 100Ω , Figure 1	
Driver Common Mode Output Voltage	V_{OC}			3	V	RL=54 or 100Ω , Figure 1	
Change in Magnitude of Common Mode Output Voltage(1)	ΔV_{OC}			0.2	V	RL=54 or 100Ω , Figure 1	
Input High Voltage	V_{IH}	2			V	DE, DI, $\overline{RE}$	
Input Low Voltage	V_{IL}			0.8	V	DE, DI, $\overline{RE}$	
Input Hysteresis	V_{HYS}		100		mV	DE, DI, $\overline{RE}$	
Input Current	I_{IN}	-1	0	1	µA	DE, DI, $\overline{RE}$	
Input Impedance First Transition (Hotswap)		1		10	kΩ	DE, $\overline{RE}$ First transition will draw more current (Hotswap)	
Output Leakage (Y and Z) Full Duplex (A and B)	I_O				µA	DE = GND V_{CC} = GND or 3.6V	V_{IN}= +12 V
				±1			V_{IN}= -7V
Driver Short-Circuit Output Current	I_{OSD}	0		±250	mA	-7V ≤ V_{OUT} ≤ 12V	
		-250		0			

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature T_{MIN} < T_A < T_{MAX}. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25°C.

PARAMETERS	SYM	MIN	TYP	MAX	UNITS	CONDITIONS	
Input Current (A and B) Half Duplex	$I_{A,B}$			125	μA	DE = GND V_{CC} = GND or 3.6	V_{IN} = +12V
		-100					V_{IN} = -7V
Thermal-Shutdown Threshold	T_{TS}		165		°C		
Thermal Shutdown Hysteresis	T_{TSH}		15		°C		
RECEIVER							
Receiver Differential Threshold Voltage	V_{TH}	-200	-125	-50	mV	-7V≤ V_{CM} ≤ 12V	
Receiver Input Hysteresis	ΔV_{TH}		15		mV	Va + Vb = 0V	
RO Output High Voltage	V_{OH}	Vcc - 0.6			V	I_O = -1mA	
RO Output Low Voltage	V_{OL}			0.4	V	I_O = 1mA	
Tri-State Output Current at Receiver	I_{OZR}			+/-1	μA	0≤ V_O ≤ V_{CC}	
Receiver Input Resistance	R_{IN}	96			kΩ	-7V ≤ V_{CM} ≤ 12V	
Receiver Ouput Short-Circuit Current	I_{OZR}	±8		±60	mA	0V ≤ V_{RO} ≤ V_{CC}	
SUPPLY CURRENT							
Supply Current	I_{CC}		0.8	1.5	mA	No Load, $\overline{RE}$ = 0, DE = V_{CC}	
			0.8	1.5		No Load, $\overline{RE}$ = V_{CC}, DE = V_{CC}	
			0.8	1.5		No Load, $\overline{RE}$ = 0, DE = 0	
Supply Current in Shutdown mode	I_{SHDN}		0.05	1	μA	$\overline{RE}$ = V_{CC}, DE = GND	
ESD PROTECTION							
ESD Protection for Y, Z, A, and B		±15			kV	Human Body Model	
		±15				Air Gap (IEC 1000-4-2)	
		±8				Contact (IEC 1000-4-2)	

DRIVER SWITCHING CHARACTERISTICS

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature $T_{MIN} < T_A < T_{MAX}$. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25ºC.

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
SP3070E, SP3071E & SP3072E DRIVER SWITCHING CHARACTERISTICS						
Driver Propagation Delay	t_{DPLH}	250	-	1500	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
	t_{DPHL}	250	-	1500	ns	
Driver Differential Output Rise or Fall Time	t_{DR}, t_{DF}	350	-	1600	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
Driver Differential Output Skew (t_{DPLH} - t_{DPHL})	t_{DSKEW}	-	-	200	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
Maximum Data Rate		250	-	-	kbps	
Driver Enable to Output High	t_{DZH}	-	-	2500	ns	Figure 4
Driver Enable to Output Low	t_{DZL}	-	-	2500	ns	Figure 5
Driver Disable Time from Low	t_{DLZ}	-	-	100	ns	Figure 5
Driver Disable Time from High	t_{DHZ}	-	-	100	ns	Figure 4
Driver Enable from Shutdown to Output High	$t_{DZH(SHDN)}$	-	-	5500	ns	Figure 4
Driver Enable from Shutdown to Output Low	$t_{DZL(SHDN)}$	-	-	5500	ns	Figure 5
Time to Shutdown	t_{SHDN}	50	200	600	ns	

RECEIVER SWITCHING CHARACTERISTICS

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature $T_{MIN} < T_A < T_{MAX}$. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25ºC.

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Receiver Switching Characteristics SP3070, SP3071 & SP3072						
Receiver Propagation Delay	t_{RPLH}	-	-	200	ns	C_L = 15pF, Figure 6 & 7
	t_{RPHL}	-	-	200	ns	
Receiver Output Skew (t_{DPLH} - t_{DPHL})	t_{RSKEW}	-	-	30	ns	C_L = 15pF, Figure 6 & 7
Data Rate		250	-	-	kbps	
Receiver Enable to Output High	t_{RZH}	-	-	50	ns	Figure 8
Receiver Enable to Output Low	t_{RZL}	-	-	50	ns	Figure 8
Receiver Disable Time from Low	t_{RLZ}	-	-	100	ns	Figure 8
Receiver Disable Time from High	t_{RHZ}	-	-	100	ns	Figure 8
Receiver Enable from Shutdown to Output High	$t_{RZH(SHDN)}$	-	-	4000	ns	Figure 8
Receiver Enable from Shutdown to Outtput Low	$t_{RZL(SHDN)}$	-	-	4000	ns	Figure 8

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature $T_{MIN} < T_A < T_{MAX}$. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25ºC.

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
SP3073E, SP3074E & SP3075E DRIVER SWITCHING CHARACTERISTICS						
Driver Propagation Delay	t_{DPLH}	180	-	800	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
	t_{DPHL}	180	-	800	ns	
Driver Differential Output Rise or Fall Time	t_{DR}, t_{DF}	200	-	800	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
Driver Differential Output Skew (t_{DPLH} - t_{DPHL})	t_{DSKEW}	-	-	100	ns	C_L = 50pF, R_L = 54Ω , Figure 2 & 3
Data Rate		500	-	-	kbps	
Driver Enable to Output High	t_{DZH}	-	-	2500	ns	Figure 4
Driver Enable to Output Low	t_{DZL}	-	-	2500	ns	Figure 5
Driver Disable Time from Low	t_{DLZ}	-	-	100	ns	Figure 5
Driver Disable Time from High	t_{DHZ}	-	-	100	ns	Figure 4
Driver Enable from Shutdown to Output High	$t_{DZH(SHDN)}$	-	-	4500	ns	Figure 4
Driver Enable from Shutdown to Output Low	$t_{DZL(SHDN)}$	-	-	4500	ns	Figure 5
Time to Shutdown	t_{SHDN}	50	200	600	ns	

Unless otherwise noted V_{CC} = +3.3 ±0.3V, ambient temperature $T_{MIN} < T_A < T_{MAX}$. Typical values are at V_{CC} = 3.3, ambient temperature T_A = +25ºC.

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Receiver Switching Characteristics SP3073, SP3074 & SP3075						
Receiver Propagation Delay	t_{RPLH}	-	-	200	ns	C_L = 15pF, Figure 6 & 7
	t_{RPHL}	-	-	200	ns	
Receiver Output Skew (t_{DPLH} - t_{DPHL})	t_{RSKEW}	-	-	30	ns	C_L = 15pF, Figure 6 & 7
Maximum Data Rate		500	-	-	kbps	
Receiver Enable to Output High	t_{RZH}	-	-	50	ns	Figure 8
Receiver Enable to Output Low	t_{RZL}	-	-	50	ns	Figure 8
Receiver Disable Time from Low	t_{RLZ}	-	-	50	ns	Figure 8
Receiver Disable Time from High	t_{RHZ}	-	-	50	ns	Figure 8
Receiver Enable from Shutdown to Output High	$t_{RZH(SHDN)}$	-	-	4000	ns	Figure 8
Receiver Enable from Shutdown to Outtput Low	$t_{RZL(SHDN)}$	-	-	4000	ns	Figure 8
Time to Shutdown	t_{SHDN}	50	200	600	ns	

Unless otherwise noted Vcc=+3.3±0.3V, ambient temperature Tmin < Ta < Tmax. Typical values are at Vcc = 3.3, ambient temperature Ta = +25ºC

SP3076E, SP3077E & SP3078E DRIVER SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Driver Propagation Delay	t_{DPLH}	-	-	50	ns	C_L = 50pF, R_L = 54Ω, Figure 2 & 3
	t_{DPHL}	-	-	50	ns	
Driver Differential Output Rise or Fall Time	t_{DR}, t_{DF}	-	-	15	ns	C_L = 50pF, R_L = 54Ω, Figure 2 & 3
Driver Differential Output Skew (t_{DPLH} - t_{DPHL})	t_{DSKEW}	-	-	8	ns	C_L = 50pF, R_L = 54Ω, Figure 2 & 3
Data Rate		16	-	-	Mbps	
Driver Enable to Output High	t_{DZH}	-	-	150	ns	Figure 4
Driver Enable to Output Low	t_{DZL}	-	-	150	ns	Figure 5
Driver Disable Time from Low	t_{DLZ}	-	-	100	ns	Figure 5
Driver Disable Time from High	t_{DHZ}	-	-	100	ns	Figure 4
Driver Enable from Shutdown to Output High	$t_{DZH(SHDN)}$	-	-	1800	ns	Figure 4
Driver Enable from Shutdown to Output Low	$t_{DZL(SHDN)}$	-	-	1800	ns	Figure 5
Time to Shutdown	t_{SHDN}	50	200	600	ns	

Unless otherwise noted Vcc=+3.3±0.3V, ambient temperature Tmin < Ta < Tmax. Typical values are at Vcc = 3.3, ambient temperature Ta = +25ºC

Receiver Switching Characteristics SP3076, SP3077 & SP3078						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Receiver Propagation Delay	t_{RPLH}	-	40	75	ns	C_L = 15pF, Figure 6 & 7
	t_{RPHL}	-	40	75	ns	
Receiver Output Skew (t_{DPLH} - t_{DPHL})	t_{RSKEW}	-	-	8	ns	C_L = 15pF, Figure 6 & 7
Data Rate		16	-	-	Mbps	
Receiver Enable to Output High	t_{RZH}	-	-	50	ns	Figure 8
Receiver Enable to Output Low	t_{RZL}	-	-	50	ns	Figure 8
Receiver Disable Time from Low	t_{RLZ}	-	-	50	ns	Figure 8
Receiver Disable Time from High	t_{RHZ}	-	-	50	ns	Figure 8
Receiver Enable from Shutdown to Output High	$t_{RZH(SHDN)}$	-	-	1800	ns	Figure 8
Receiver Enable from Shutdown to Output Low	$t_{RZL(SHDN)}$	-	-	1800	ns	Figure 8
Time to Shutdown	t_{SHDN}	50	200	600	ns	

FIGURE 1. DRIVER DC TEST CIRCUIT
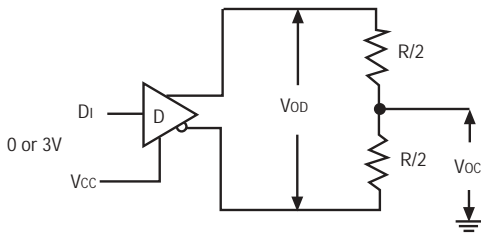
FIGURE 2. RECEIVER DC TEST CIRCUIT

FIGURE 3. DRIVER PROPAGATION DELAY TIME TEST CIRCUIT AND TIMING DIAGRAM

$V_{DIFF} = V(Y) - V(Z)$

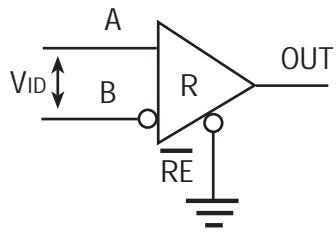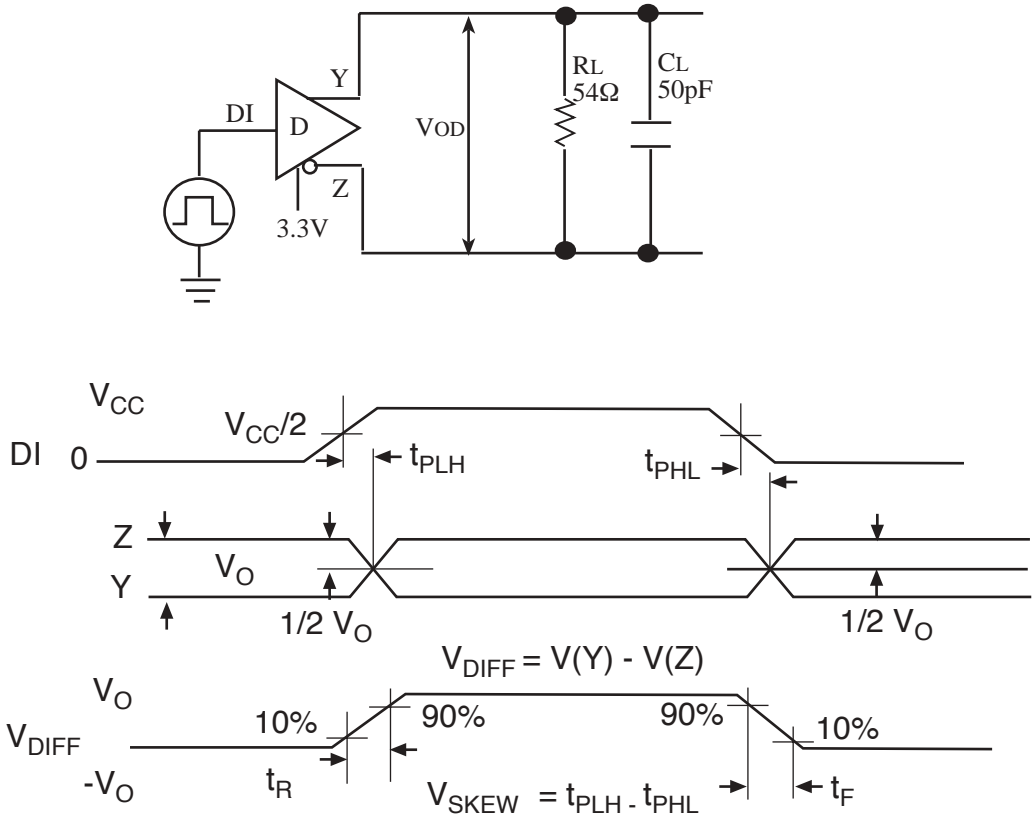$V_{SKEW} = t_{PLH} - t_{PHL}$

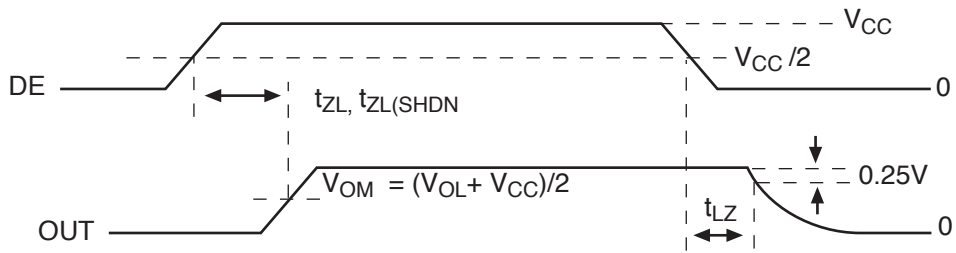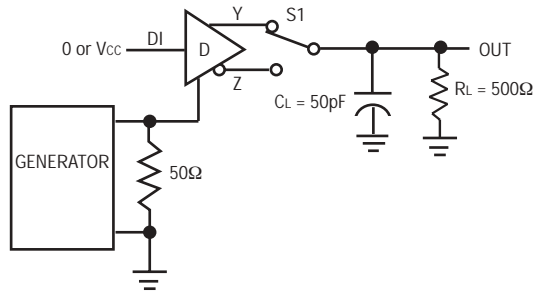**FIGURE 4. DRIVER ENABLE & DISABLE TIMES TEST CIRCUIT & TIMING DIAGRAM**

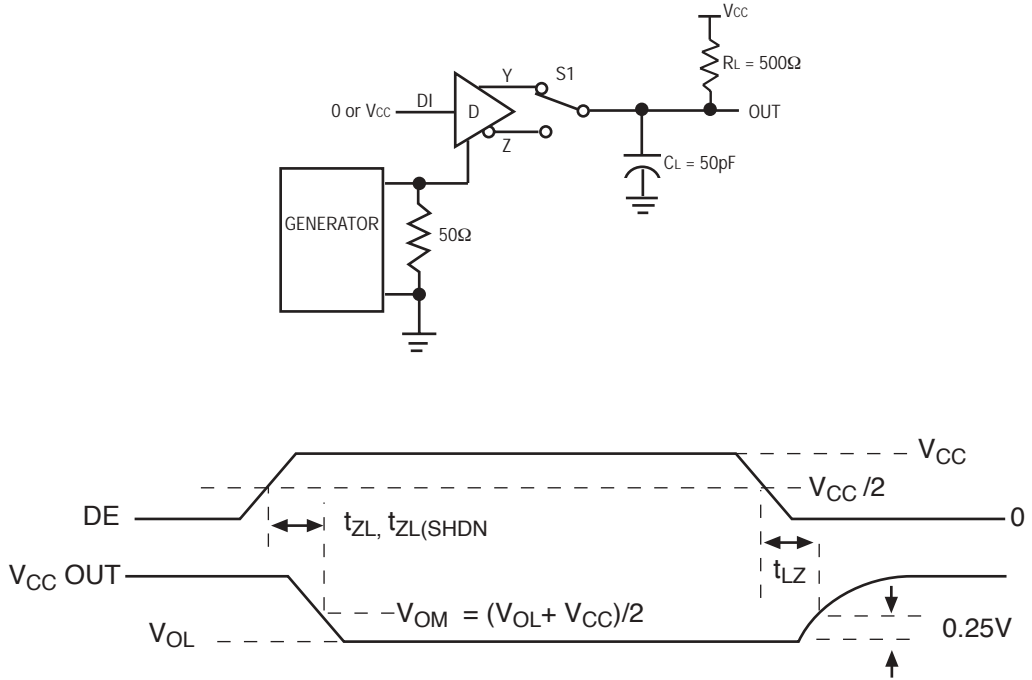## FIGURE 5. DRIVER ENABLE & DISABLE TIMES TEST CIRCUIT & TIMING DIAGRAM

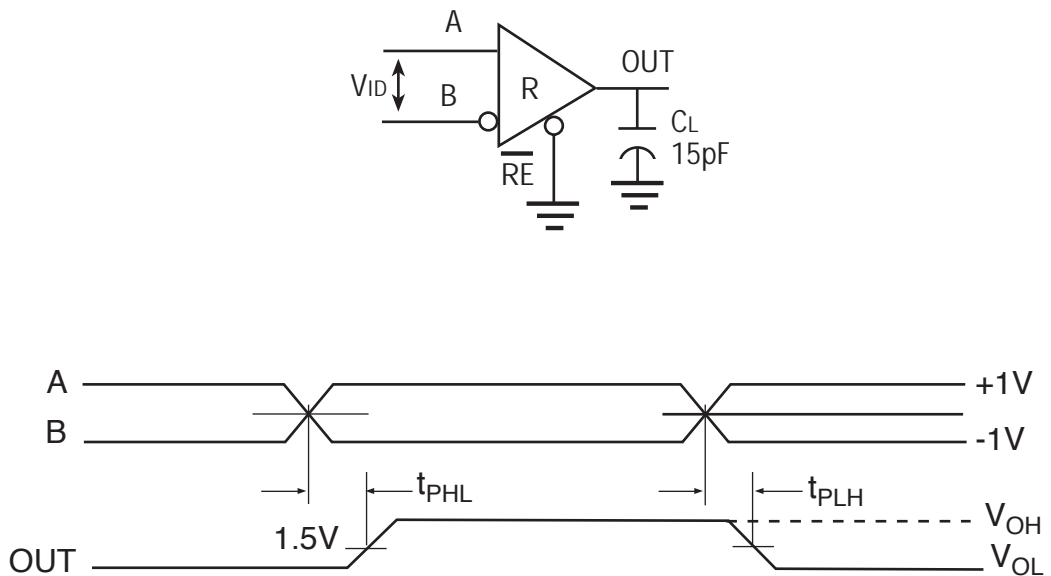## FIGURE 6. RECEIVER PROPAGATION DELAY TEST CIRCUIT & TIMING DIAGRAM
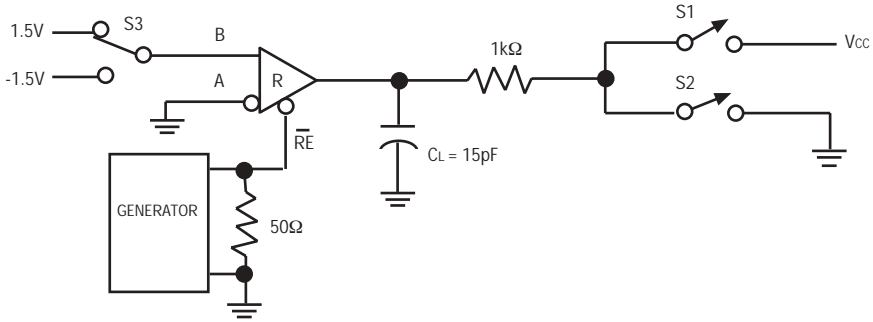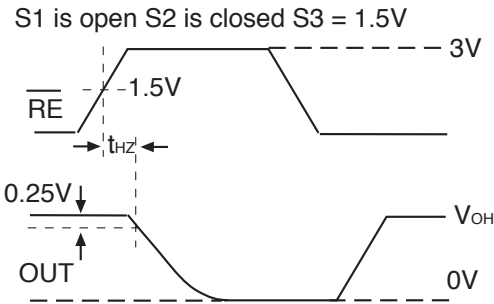
FIGURE 7. RECEIVER ENABLE & DISABLE TIMES TEST CIRCUIT

FIGURE 8. RECEIVER ENABLE & DISABLE TIMING DIAGRAM

S1 is open S2 is closed S3 = 1.5V

$\overline{RE}$

3V

1.5V

$t_{ZH}, t_{ZH(SHDN)}$

OUT

V_{OH}

$V_{OH}/2$

0V

S1 is closed, S2 is open, S3 = -1.5V

$\overline{RE}$

3V

1.5V

0V

$t_{ZL}, t_{ZL(SHDN)}$

OUT

V_{CC}

$V_{OL} = V_{CC}/2$

V_{OL}

S1 is open S2 is closed S3 = 1.5V

$\overline{RE}$

3V

1.5V

t_{HZ}

0.25V

OUT

V_{OH}

0V

S1 is closed, S2 is open, S3 = -1.5V

$\overline{RE}$

3V

1.5V

0V

t_{LZ}

OUT

V_{CC}

0.25V

V_{OL}
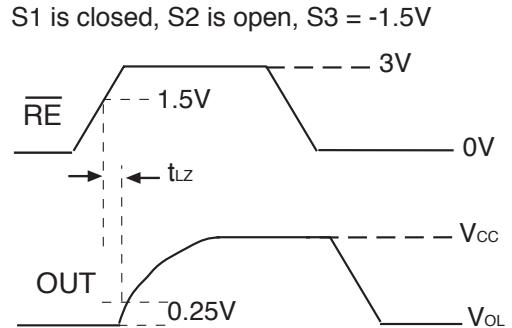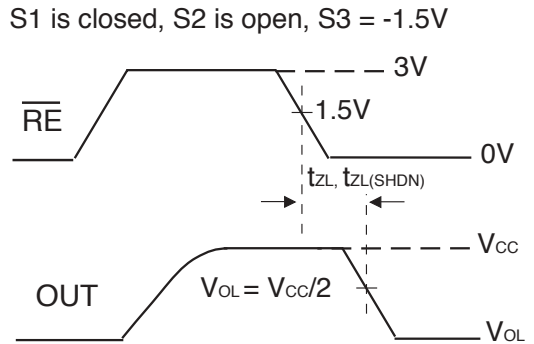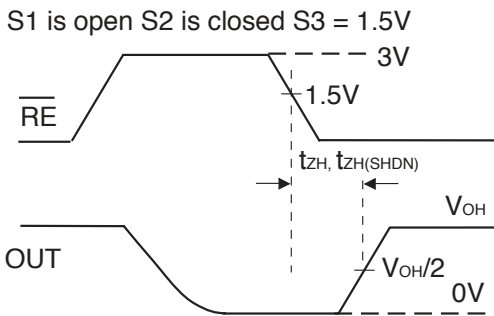
SP3070E, SP3073E, SP3076E								
TRANSMITTING					RECEIVING			
Inputs			Outputs		Inputs			Output
$\overline{RE}$	DE	DI	Z	Y	$\overline{RE}$	DE	A, B	RO
X	1	1	0	1	0	X	≥ -50mV	1
X	1	0	1	0	0	X	≤ -200mV	0
0	0	X	High-Z		X	X	1	
1	0	X	Shutdown		1	X	High-Z	
					1	0	X	Shutdown

SP3070E, SP3073E, SP3076E				
TRANSMITTING			RECEIVING	
Inputs	Outputs		Inputs	Output
DI	Z	Y	A, B	RO
1	0	1	≥ -50mV	1
0	1	0	≤ -200mV	0
			Open/shorted	1

SP3072E, SP3075E, SP3078E								
TRANSMITTING					RECEIVING			
Inputs			Outputs		Inputs			Output
$\overline{RE}$	DE	DI	B/Z	A/Y	$\overline{RE}$	DE	A, B	RO
X	1	1	0	1	0	X	≥ -50mV	1
X	1	0	1	0	0	X	≤ -200mV	0
0	0	X	High-Z		X	Open/shorted	1	No Load
1	0	X	Shutdown		1	X	High-Z	
					1	0	X	Shutdown

FULL DUPLEX DEVICES		HALF DUPLEX DEVICES	PIN NAME	PIN FUNCTION
SP3070E	SP3071E	SP3072E		
SP3073E	SP3074E	SP3075E		
SP3076E	SP3077E	SP3078E		
PIN NUMBER				
2	2	1	RO	Receiver Output. When $\overline{RE}$ is low and if (A − B) ≥ -50mV, RO is High. If (A − B) ≤ - 200mV, RO is low.
3	-	2	$\overline{RE}$	Receiver Output Enable. When $\overline{RE}$ is low, RO is enabled. When $\overline{RE}$ is high, RO is high impedance. $\overline{RE}$ should be high and DE low to enter shutdown mode. $\overline{RE}$ is a hot-swap input.
4	-	3	DE	Driver Output Enable. When DE is high, outputs are enabled. When DE is low, outputs are high impedance. DE should be low and $\overline{RE}$ high to enter shutdown mode. DE is a hot-swap input.
5	3	4	DI	Driver Input. With DE high, a low level on DI forces noninverting output low and inverting output high. Similarly, a high level on DI forces noninverting output high and inverting output low.
6, 7	4	5	GND	Ground
9	5	-	Y	Noninverting Driver Output
10	6	-	Z	Inverting Driver Output
11	7	-	B	Inverting Receiver Input
-	-	7	B	Inverting Receiver Input and Inverting Driver Output
12	8	-	A	Noninverting Receiver Input
-	-	6	A	Noninverting Receiver Input and Noninverting Driver Output
14	1	8	V_{CC}	Positive Supply V_{CC}. Bypass V_{CC} to GND with a 0.1uF capacitor.
1, 8, 13	-	-	NC	No Connect

DETAILED DESCRIPTION

The SP307XE family of high speed transceivers for RS-485/RS-422 communication contain one driver and one receiver. These devices feature fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled. The SP3070E, SP3072E, SP3073E, SP3075E, SP3076E and SP3078E also feature a hotswap capability allowing live insertion without error data transfer. The SP3070E, SP3071E and SP3072E feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission up to 250kbps. The SP3073E, SP3074E and SP3075E also offer slew -rate limits allowing transmit speeds up to 500kbps. The SP3076E, SP3077E, SP3078E driver slew rates are not limited, making transmit speeds up to 16Mbps possible.

The SP3072E, SP3075E and SP3078E are half-duplex transceivers, while the SP3070E, SP3071E, SP3073E, SP3074E, SP3076E, and SP3077E are full duplex transceivers.

All devices operate from a single 3.3V supply. Drivers are output short-circuit current limited. Thermal-shutdown circuitry protects drivers against excessive power dissipation. When activated, the thermal-shutdown circuitry places the driver outputs into a high-impedance state.

RECEIVER INPUT FILTERING

SP3070-SP3075 receivers incorporate input filtering in addition to input hysteresis. This filtering enhances noise immunity with differential signals that have very slow rise and fall times. Receiver propagation delay increases by 25% due to this filtering.

FAIL SAFE

The SP3070 family guarantees a logic-high receiver output when the receiver inputs are shorted, open, or when they are connected to a terminated transmission line with all drivers

disabled. If A - B is less than or equal to -200mV, RO is logic low. In the case of a terminated bus with all transmitters disabled the receiver's differential input voltage is pulled to 0V by the termination. With the receiver thresholds of the SP3070E family, this results in a logic high with a 50mV minimum noise margin. In compliance with the EIA/TIA-485 standard, the SP3070E family has a 50mV -200mV threshold.

HOT-SWAP CAPABILITY

When circuit boards are inserted into a hot backplane, differential disturbances to the data bus can lead to data errors. Upon initial circuit board insertion, the data communication processor undergoes its own power-up sequence. During this period, the processor's logic-output drivers are high impedance and are unable to drive the DE and $\overline{RE}$ inputs of these devices to a defined logic level. Leakage currents up to 10μA from the high-impedance state of the processor's logic drivers could cause standard CMOS enable inputs of a transceiver to drift to an incorrect logic level. Additionally, parasitic circuit board capacitance could cause coupling of VCC or GND to the enable inputs. Without the hot-swap capability, these factors could improperly enable the transceiver's driver or receiver.

When VCC rises, an internal pulldown circuit holds DE low and $\overline{RE}$ high for approximately 10 microseconds. After the initial power-up sequence, the pulldown circuit becomes transparent, resetting the hot-swap tolerable input.

15KV ESD PROTECTION

As with all Sipex devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver output and receiver inputs of the SP3070E family of devices have extra protection against static electricity. Sipex's engineering team have developed state of the art structures to protect these pins against ESD of 15kV without damage. The ESD structures withstand high ESD in all states: normal op-

eration, shutdown, and powered down. After an ESD event, the SP3070E - SP3078E keep working without latchup or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the SP3070E - SP3078E are characterized for protection to the following limits:

■ ±15kV using the Human Body Model

■ ±8kV using the Contact Discharge method specified in IEC 1000-4-2

■ ±15kV Airgap

ESD TEST CONDITIONS
ESD performance depends on a variety of conditions. Contact Sipex for a reliability report that documents test setup, methodology and results.

IEC 1000-4-2
The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The SP3070E family of devices helps you design equipment to meet IEC 1000-4-2, without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2, because series resistance is lower in the IEC 1000-4-2 model. Hence, the ESD withstand voltage measured to EC 1000-4-2 is generally lower than that measured using the human body model.

The air-gap test involves approaching the device with a charged probe. The contact-discharge method connects the probe to the device before the probe is energized.

MACHINE MODEL
The machine model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. The objective is to emulate the stress caused when I/O pins are contacted by handling equipment during test and assembly.

256 TRANSCEIVERS ON THE BUS
The standard RS-485 receiver input impedance is 12kΩ (1 unit load), and the standard driver can drive up to 32 unit loads. The SP3070E family of transceivers has a 1/8-unit load receiver input impedance (96Ω), allowing up to 256 transceivers to be connected in parallel on one communication line. Any combination of these devices as well as other RS-485 transceivers with a total of 32 unit loads or fewer can be connected to the line.

REDUCED EMI AND REFLECTIONS
The SP3070E, SP3071E and SP3072E feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission up to 250kbps. The SP3073, SP3074 and SP3075 offer higher driver output slew-rate limits, allowing transmit speeds up to 500kbps.

LOW POWER SHUTDOWN MODE
Low-power shutdown mode is initiated by bringing both $\overline{RE}$ high and DE low. In shutdown, the devices typically draw only 50nA of supply current.

$\overline{RE}$ and DE can be driven simultaneously; the parts are guaranteed not to enter shutdown if $\overline{RE}$ is high and DE is low for less than 50ns. If the inputs are in this state for at least 600ns, the parts are guaranteed to enter shutdown.

Enable times t_{ZH} and t_{ZL} assume the part was not in a low-power shutdown state. Enable times $t_{ZH(SHDN)}$ and $t_{ZL(SHDN)}$ assume the parts were shut down. It takes drivers and receivers longer to become enabled from low-power shutdown mode $t_{ZH(SHDN)}$ and $t_{ZL(SHDN)}$ than from driver/receiver-disable mode (t_{ZH}, t_{ZL})

DRIVER OUTPUT PROTECTION
Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. First, current limit on the ouput stage, provides immediate protection against short circuits over the whole common-mode voltage range. Second, a thermal-shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature becomes excessive.

LINE LENGTH
The RS-485/RS422 standard covers line lengths up to 4000ft.

TYPICAL APPLICATIONS
The SP3072E, SP3075E and SP3078E transceivers are designed for bidirectional data communications on multipoint bus transmission lines.

To minimize reflections, terminate the line at both ends in its characteristic imped-ance, and keep stub lengths off the main line as short as possible. The slew-rate-limited SP3072E and SP3075 are more tolerant of imperfect termination.

PART NUMBER	HALF/FULL DUPLEX	DATA RATE Mbps	SHUT-DOWN	RECEIVER DRIVER ENABLE	TRANS. ON BUS	PIN COUNT	INDUSTRY STANDARD PINOUT
SP3070E	Full	0.25	Yes	Yes	256	14	MAX3070E, 75180
SP3071E	Full	0.25	No	No	256	8	MAX3071E, 75179
SP3072E	Half	0.25	Yes	Yes	256	8	MAX3072E, 75176
SP3073E	Full	0.5	Yes	Yes	256	14	MAX3073E, 75180
SP3074E	Full	0.5	No	No	256	8	MAX3074E, 75179
SP3075E	Half	0.5	Yes	Yes	256	8	MAX3075E, 75176
SP3076E	Full	16	Yes	Yes	256	14	MAX3076E, 75180
SP3077E	Full	16	No	No	256	8	MAX3077E, 75179
SP3078E	Half	16	Yes	Yes	256	8	MAX3078E, 75176

PINOUT DRAWINGS

SP3071E, SP3074E, AND SP3077E


SP3072E, SP3075E, AND SP3078E
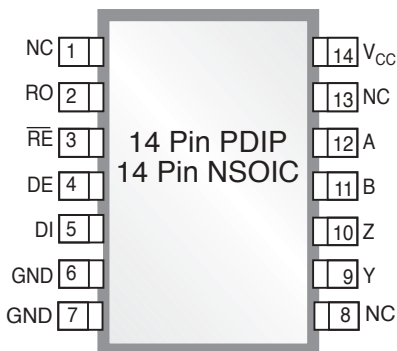
SP3070E, SP3073E, AND SP3076E
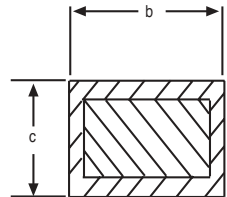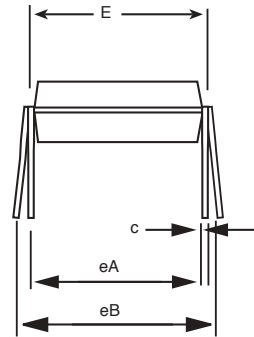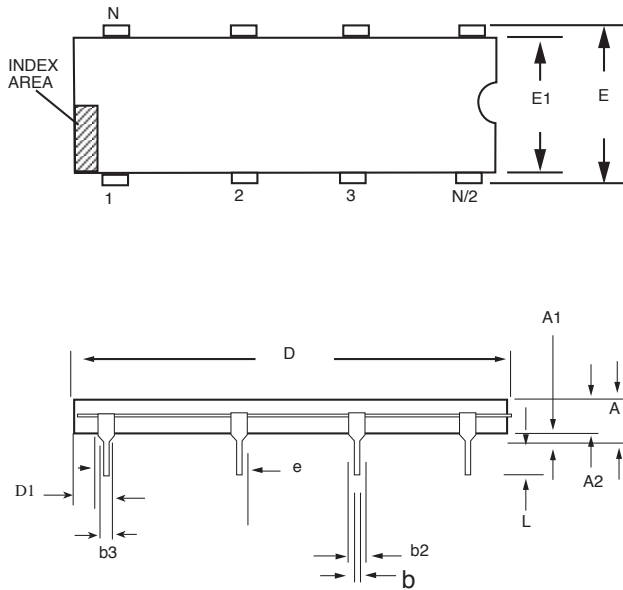
8 PIN PDIP JEDEC MS-001 (BA) Variation			
SYMBOL	MIN	NOM	MAX
A	-	-	0.21
A1	0.15	-	-
A2	0.115	0.13	0.195
b	0.014	0.018	0.022
b2	0.045	0.06	0.07
b3	0.3	0.039	0.045
c	0.008	0.01	0.014
D	0.355	0.365	0.4
D1	0.005	-	-
E	0.3	0.31	0.325
E1	0.24	0.25	0.28
e	.100 BSC		
eA	.300 BSC		
eB	-	-	0.43
L	0.115	0.13	0.15

Note: Dimensions in (mm)
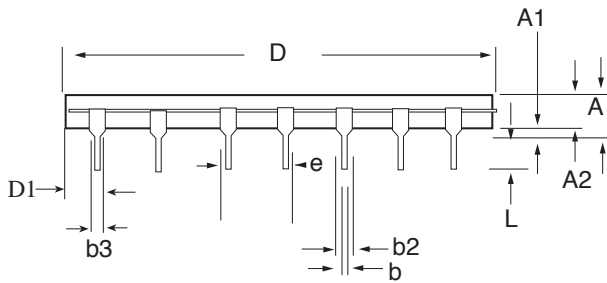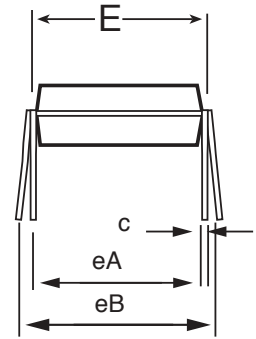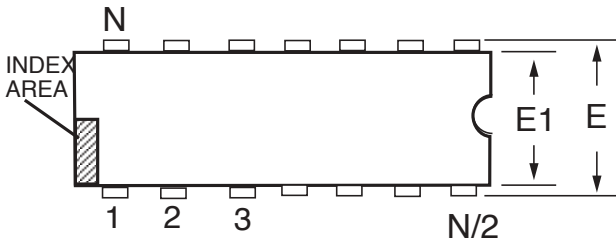
14 PIN PDIP JEDEC MS-001 (AA) Variation			
SYMBOL	MIN	NOM	MAX
A	-	-	0.21
A1	0.15	-	-
A2	0.115	0.13	0.195
b	0.014	0.018	0.022
b2	0.045	0.06	0.07
b3	0.3	0.039	0.045
c	0.008	0.01	0.014
D	0.735	0.75	0.755
D1	0.005	-	-
E	0.3	0.31	0.325
E1	0.24	0.25	0.28
e	.100 BSC		
eA	.300 BSC		
eB	-	-	0.43
L	0.115	0.13	0.15

Note: Dimensions in (mm)

TOP VIEW

INDEX AREA
(D/2 X E1/2)

VIEW C

Seating Plane

SIDE VIEW

SEE VIEW C
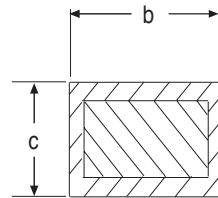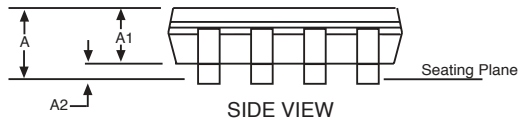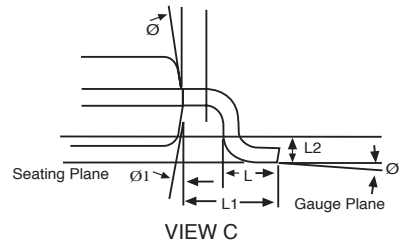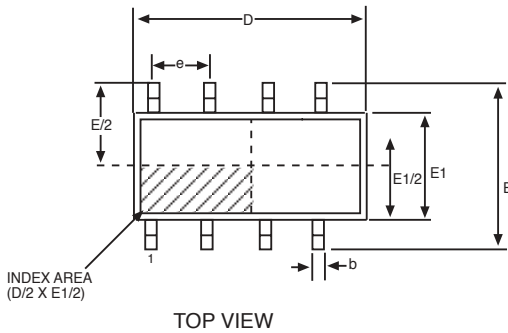
8 Pin NSOIC JEDEC MO-012 (AA) Variation			
SYMBOL	MIN	NOM	MAX
A	1.35	-	1.75
A1	0.1	-	0.25
A2	1.25	-	1.65
b	0.31	-	0.51
c	0.17	-	0.24
D		4.90 BSC	
E		6.00 BSC	
E1		3.90 BSC	
e		1.27 BSC	
L	0.4	-	1.27
L1		1.04 REF	
L2		0.25 BSC	
ø	0º	-	8º
ø1	5º	-	15º

Note: Dimensions in (mm)

BASE METAL

SECTION B-B
WITH PLATING

INDEX AREA
(D/2 X E1/2)

1

TOP VIEW

VIEW C

Seating Plane

SIDE VIEW

SEE VIEW C
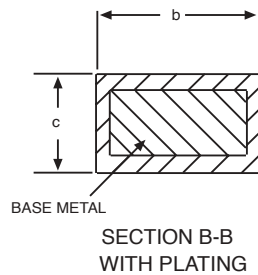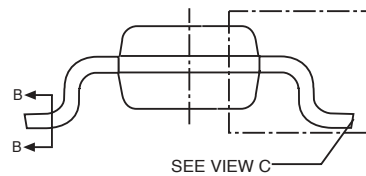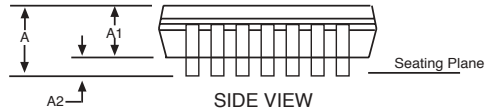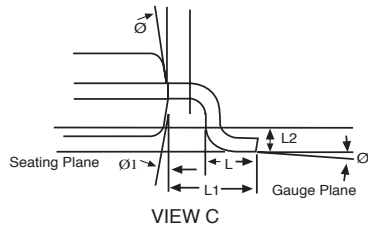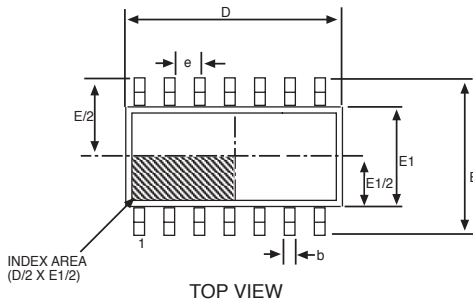
14 Pin NSOIC JEDEC MO-012 (AB) Variation			
SYMBOL	MIN	NOM	MAX
A	1.35	-	1.75
A1	0.1	-	0.25
A2	1.25	-	1.65
b	0.31	-	0.51
c	0.17	-	0.25
D	8.65 BSC		
E	6.00 BSC		
E1	3.90 BSC		
e	1.27 BSC		
L	0.4	-	1.27
L1	1.04 REF		
L2	0.25 BSC		
ø	0º	-	8º
ø1	5º	-	15º

Note: Dimensions in (mm)

BASE METAL

SECTION B-B
WITH PLATING
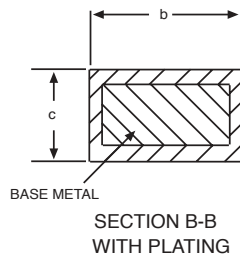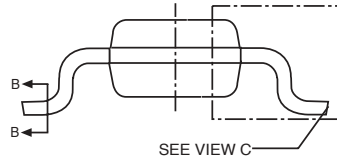
Model	Temperature Range	Package
SP3070ECN	0˚C to +70˚C	14-pin NSOIC
SP3070ECN/TR	0˚C to +70˚C	14-pin NSOIC
SP3070ECP	0˚C to +70˚C	14-pin PDIP
SP3070EEN	-40˚C to +85˚C	14-pin NSOIC
SP3070EEN/TR	-40˚C to +85˚C	14-pin NSOIC
SP3070EEP	-40˚C to +85˚C	14-pin PDIP
SP3071ECN	0˚C to +70˚C	8-pin NSOIC
SP3071ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3071ECP	0˚C to +70˚C	8-pin PDIP
SP3071EEN	-40˚C to +85˚C	8-pin NSOIC
SP3071EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3071EEP	-40˚C to +85˚C	8-pin PDIP
SP3072ECN	0˚C to +70˚C	8-pin NSOIC
SP3072ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3072ECP	0˚C to +70˚C	8-pin PDIP
SP3072EEN	-40˚C to +85˚C	8-pin NSOIC
SP3072EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3072EEP	-40˚C to +85˚C	8-pin PDIP
SP3073ECN	-0˚C to +70˚C	14-pin NSIOC
SP3073ECN/TR	-0˚C to +70˚C	14-pin NSIOC
SP3073ECP	0˚C to +70˚C	14-pin PDIP
SP3073EEN	-40˚C to +85˚C	14-pin NSIOC
SP3073EEN/TR	-40˚C to +85˚C	14-pin NSIOC
SP3073EEP	-40˚C to +85˚C	14-pin PDIP
SP3074ECN	0˚C to +70˚C	8-pin NSOIC
SP3074ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3074ECP	0˚C to +70˚C	8-pin PDIP
SP3074EEN	-40˚C to +85˚C	8-pin NSOIC
SP3074EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3074EEP	-40˚C to +85˚C	8-pin PDIP

Available in lead free packaging. To order add "-L" suffix to part number.

Example: SP3074EEN/TR = standard; SP3074EEN-L/TR = lead free

/TR = Tape and Reel

Pack quantity is 2,500 for NSOIC.

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Sipex
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ANALOG EXCELLENCE

Sipex Corporation

**Headquarters and
Sales Office**
233 South Hillview Drive
Milpitas, CA 95035
TEL: (408) 934-7500
FAX: (408) 935-7600

Model	Temperature Range	Package
SP3075ECN	0˚C to +70˚C	8-pin NSOIC
SP3075ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3075ECP	0˚C to +70˚C	8-pin PDIP
SP3075EEN	-40˚C to +85˚C	8-pin NSOIC
SP3075EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3075EEP	-40˚C to +85˚C	8-pin PDIP
SP3076ECN	0˚C to +70˚C	14-pin NSOIC
SP3076ECN/TR	0˚C to +70˚C	14-pin NSOIC
SP3076ECP	0˚C to +70˚C	14-pin PDIP
SP3076EEN	-40˚C to +85˚C	14-pin NSOIC
SP3076EEN/TR	-40˚C to +85˚C	14-pin NSOIC
SP3076EEP	-40˚C to +85˚C	14-pin PDIP
SP3077ECN	0˚C to +70˚C	8-pin NSOIC
SP3077ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3077ECP	0˚C to +70˚C	8-pin PDIP
SP3077EEN	-40˚C to +85˚C	8-pin NSOIC
SP3077EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3077EEP	-40˚C to +85˚C	8-pin PDIP
SP3078ECN	0˚C to +70˚C	8-pin NSOIC
SP3078ECN/TR	0˚C to +70˚C	8-pin NSOIC
SP3078ECP	0˚C to +70˚C	8-pin PDIP
SP3078EEN	-40˚C to +85˚C	8-pin NSOIC
SP3078EEN/TR	-40˚C to +85˚C	8-pin NSOIC
SP3078EEP	-40˚C to +85˚C	8-pin PDIP

Available in lead free packaging. To order add "-L" suffix to part number.

Example: SP3078EEN/TR = standard; SP3078EEN-L/TR = lead free

/TR = Tape and Reel

Pack quantity is 2,500 for NSOIC.

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